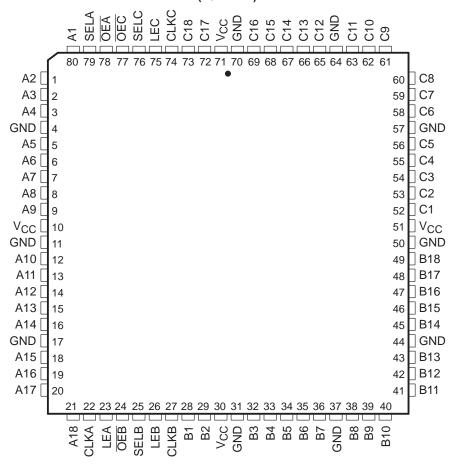
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- Members of the Texas Instruments
 Widebus+™ Family
- State-of-the-Art EPIC-IIB™ BiCMOS Design Significantly Reduces Power Dissipation
- UBE™ (Universal Bus Exchanger)
 Combines D-Type Latches and D-Type
 Flip-Flops for Operation in Transparent,
 Latched, or Clocked Mode
- Latch-Up Performance Exceeds 500 mA Per JEDEC Standard JESD-17
- Typical V_{OLP} (Output Ground Bounce)
 < 0.8 V at V_{CC} = 5 V, T_A = 25°C

- High-Impedance State During Power Up and Power Down
- Distributed V_{CC} and GND Pin Configuration Minimizes High-Speed Switching Noise
- High-Drive Outputs (-32-mA I_{OH}, 64-mA I_{OL})
- Bus Hold on Data Inputs Eliminates the Need for External Pullup/Pulldown Resistors
- Package Options Include 80-Pin Plastic
 Thin Quad Flat (PN) Package With
 12 × 12-mm Body Using 0.5-mm Lead Pitch and 84-Pin Ceramic Quad Flat (HT) Package

SN74ABTH32318 . . . PN PACKAGE (TOP VIEW)

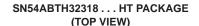


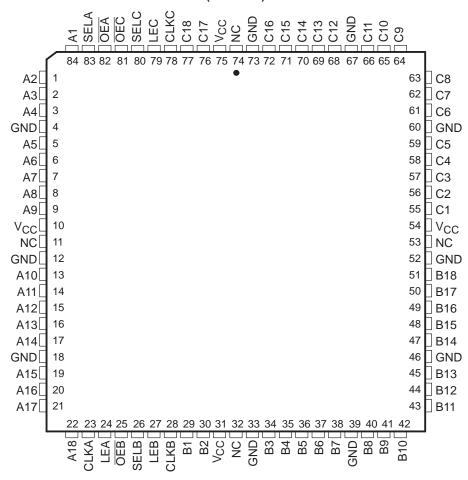


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NC - No internal connection

description

The 'ABTH32318 consist of three 18-bit registered input/output (I/O) ports. These registers combine D-type latches and flip-flops to allow data flow in transparent, latch, and clock modes. Data from one input port can be exchanged to one or more of the other ports. Because of the universal storage element, multiple combinations of real-time and stored data can be exchanged among the three ports.

Data flow in each direction is controlled by the output-enable (\overline{OEA} , \overline{OEB} , and \overline{OEC}), select-control (SELA, SELB, and SELC), latch-enable (LEA, LEB, and LEC), and clock (CLKA, CLKB, and CLKC) inputs. The A data register operates in the transparent mode when LEA is high. When LEA is low, data is latched if CLKA is held at a high or low logic level. If LEA is low, data is stored on the low-to-high transition of CLKA. Output data selection is accomplished by the select-control pins. All three ports have active-low output enables, so when the output-enable input is low, the outputs are active; when the output-enable input is high, the outputs are in the high-impedance state.

When V_{CC} is between 0 and 2.1 V, the device is in the high-impedance state during power up or power down. However, to ensure the high-impedance state above 2.1 V, \overline{OE} should be tied to V_{CC} through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

Active bus-hold circuitry is provided to hold unused or floating data inputs at a valid logic level.



description (continued)

The SN54ABTH32318 is characterized for operation over the full military temperature range of –55°C to 125°C. The SN74ABTH32318 is characterized for operation from –40°C to 85°C.

Function Tables

STORAGE†

l	NPUTS		ОИТРИТ
CLKA	LEA	Α	OUIPUI
1	L	L	L
1	L	Н	Н
Н	L	Χ	Q ₀ ‡ Q ₀ ‡
L	L	Χ	Q ₀ ‡
Х	Н	L	L
Х	Н	Н	Н

[†] A-port register shown. B and C ports are similar but use CLKB, CLKC, LEB, and LEC.

A-PORT OUTPUT

INP	UTS	OUTPUT A
OEA	SELA	OUTPUT A
Н	Х	Z
L	Н	Output of C register
L	L	Output of B register

B-PORT OUTPUT

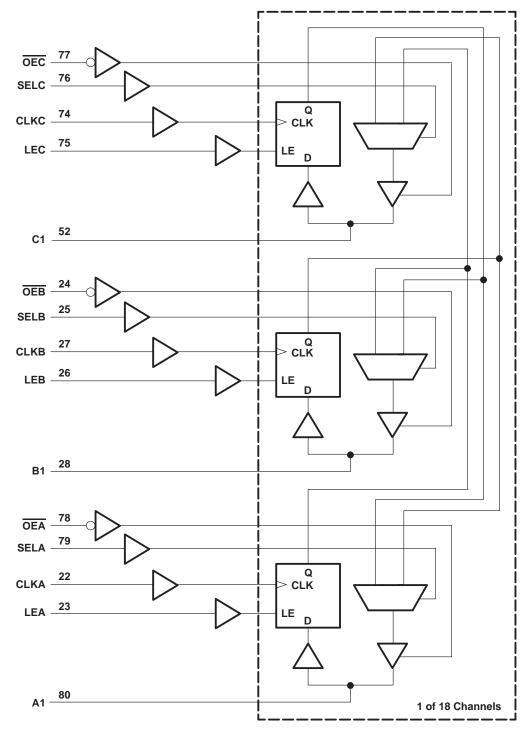
I	INP	UTS	OUTPUT D
	OEB	SELB	OUTPUT B
I	Н	Х	Z
I	L	Н	Output of A register
I	L	L	Output of C register

C-PORT OUTPUT

INF	PUTS	OUTPUT C
OEC	SELC	OUTPUT C
Н	Х	Z
L	Н	Output of B register
L	L	Output of A register

Output level before the indicated steady-state input conditions were established

logic diagram (positive logic)



Pin numbers shown are for the PN package.



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absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage range, V _{CC}	0.5 V to 7 V
Input voltage range, V _I (except I/O ports) (see Note 1)	0.5 V to 7 V
Voltage range applied to any output in the high or power-off state, VO	–0.5 V to 5.5 V
Current into any output in the low state, IO: SN54ABTH32318	96 mA
SN74ABTH32318	128 mA
Input clamp current, I _{IK} (V _I < 0)	–18 mA
Output clamp current, I _{OK} (V _O < 0)	–50 mA
Package thermal impedance, θ _{JA} (see Note 2): PN package	62°C/W
Storage temperature range, T _{stg}	–65°C to 150°C

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

recommended operating conditions (see Note 3)

		SN54ABTI	H32318	SN74ABTI	132318	UNIT	
			MIN	MAX	MIN	MAX	UNIT
VCC	Supply voltage		4.5	5.5	4.5	5.5	V
VIH	High-level input voltage	2	EN.	2		V	
V _{IL}	Low-level input voltage		0.8		0.8	V	
VI	Input voltage	00	VCC	0	VCC	V	
loн	High-level output current		, C	-24		-32	mA
loL	Low-level output current		20	48		64	mA
Δt/Δν	Input transition rise or fall rate	Outputs enabled	PA	10		10	ns/V
Δt/ΔV _{CC}	Power-up ramp rate		200		200		μs/V
TA	Operating free-air temperature	-55	125	-40	85	°C	

NOTE 3: Unused control pins must be held high or low to prevent them from floating.

NOTES: 1. The input and output negative-voltage ratings may be exceeded if the input and output clamp-current ratings are observed.

^{2.} The package thermal impedance is calculated in accordance with EIA/JEDEC Std JESD51.

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electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST COM	NITIONS	SN54	ABTH3	2318	SN74	4ABTH32	2318	UNIT	
	RAMETER	TEST CONDITIONS			TYP [†]	MAX	MIN	TYP†	MAX	UNII	
VIK		$V_{CC} = 4.5 \text{ V}, \qquad I_{I} = -18 \text{ mA}$				-1.2			-1.2	V	
		$V_{CC} = 4.5 \text{ V},$	I _{OH} = -3 mA	2.5			2.5				
\/~		$V_{CC} = 5 V$,	$I_{OH} = -3 \text{ mA}$	3			3			V	
VOH		V _{CC} = 4.5 V	$I_{OH} = -24 \text{ mA}$	2						V	
		VCC = 4.5 V	$I_{OH} = -32 \text{ mA}$				2				
VOL		V _{CC} = 4.5 V	$I_{OL} = 48 \text{ mA}$			0.55			0.55	V	
VOL		VCC = 4.5 V	$I_{OL} = 64 \text{ mA}$			0.55			0.55	V	
V _{hys}					100	2		100		mV	
1.	Control inputs	$V_{CC} = 0 \text{ to } 5.5 \text{ V},$	$V_I = V_{CC}$ or GND		1	±1			±1	μА	
<u> </u>	A, B, or C ports	$V_{CC} = 2.1 \text{ V to } 5.5 \text{ V},$	$V_I = V_{CC}$ or GND		2/5	±20			±20	μΑ	
lia i s	A. D. ou C. nouto	B, or C ports $V_{CC} = 4.5 \text{ V}$	V _I = 0.8 V	100	Z.		100			μΑ	
l(hold)	A, B, or C ports	VCC = 4.5 V	V _I = 2 V	-100	S		-100			μΑ	
lozpu [‡]	-	$V_{CC} = 0 \text{ to } 2.1 \text{ V}, V_{O} = 0.5 \text{ V to } 2.7 \text{ V}, \overline{OE} = X$		ć	2	±50			±50	μΑ	
lozpd [‡]		$V_{CC} = 2.1 \text{ V to } 0, V_{O} = 0.5 \text{ V to } 2.7 \text{ V}, \overline{OE} = X$		Q		±50			±50	μΑ	
l _{off}		$V_{CC} = 0$,	V_I or $V_O \le 4.5 \text{ V}$			±100			±100	μΑ	
ICEX		$V_{CC} = 5.5 \text{ V}, V_{O} = 5.5 \text{ V}$	Outputs high			50			50	μΑ	
IO§		V _{CC} = 5.5 V,	V _O = 2.5 V	-50	-100	-180	-50	-100	-180	mA	
		V _{CC} = 5.5 V,	Outputs high			2			2		
Icc		$I_O = 0$,	Outputs low			45			45	mA	
		$V_I = V_{CC}$ or GND	Outputs disabled			1			1		
ΔICC¶		V _{CC} = 5.5 V, One input at 3.4 V, Other inputs at V _{CC} or GND				0.5			0.5	mA	
Ci	Control inputs	V _I = 2.5 V or 0.5 V			3			3		pF	
C _{io}	A, B, or C ports	V _O = 2.5 V or 0.5 V			11.5			11.5		pF	

[†] All typical values are at $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$.

timing requirements over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted) (see Figure 1)

		SN54ABT	H32318	SN74ABTI	UNIT		
		MIN	MAX	MIN	MAX	UNIT	
fclock	Clock frequency		150		150	MHz	
A Dula	Pulse duration	LE high	3.3	3.3			no
t _W	ruise duration	3.3	N. C.	3.3		ns	
	Catum time	A, B, or C before CLK↑	2.4		2.4		
t _{su}	Setup time	A, B, or C before LE↓	2.1		2.1		ns
t.	Hold time	A, B, or C after CLK↑	0.4		1.4		no
th	noid title	2.1		2.1		ns	

[‡] This parameter is specified by characterization.

[§] Not more than one output should be tested at a time, and the duration of the test should not exceed one second.

 $[\]P$ This is the increase in supply current for each input that is at the specified TTL voltage level rather than V_{CC} or GND.

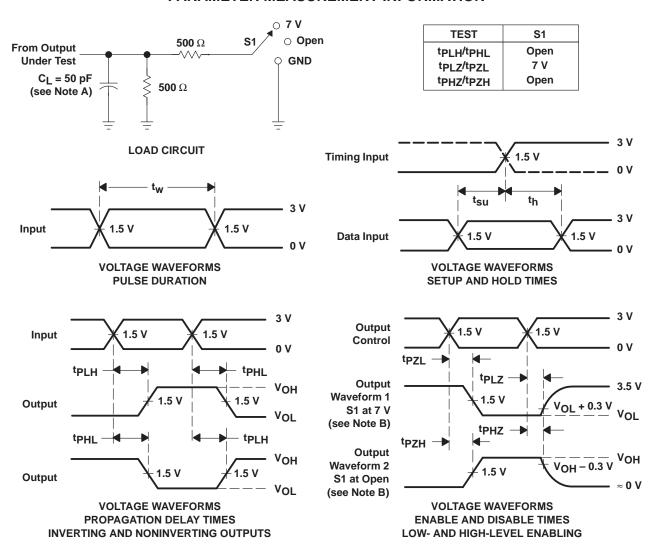
SN54ABTH32318, SN74ABTH32318 18-BIT TRI-PORT UNIVERSAL BUS EXCHANGERS

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switching characteristics over recommended ranges of supply voltage and operating free-air temperature, C_L = 50 pF (unless otherwise noted) (see Figure 1)

PARAMETER	FROM	то	SN54ABTI	H32318	SN74ABT	UNIT	
FARAMETER	(INPUT)	(OUTPUT)	MIN	MAX	MIN	MAX	CIVIT
f _{max}			150		150		MHz
^t PLH	A, B, or C	C, B, or A	1.4	6.5	1.4	6.1	ns
^t PHL	A, B, or C	C, B, of A	1.1	6.8	1.1	6.6	115
^t PLH	SEL	A, B, or C	1.4	6.7	1.4	6.5	ns
^t PHL	JLL	A, B, or C	1.8	6.8	1.8	6.5	115
^t PLH	LE	LE A, B, or C		8	2.6	7.5	ns
^t PHL		A, B, or C	2.6	7.4	2.6	6.9	115
^t PLH	CLK	A, B, or C	2.5	8	2.5	7.4	ns
^t PHL	OLK	A, B, or C	2.5	7.2	2.5	6.7	115
^t PZH	ŌĒ	A, B, or C	1.4	6.9	1.4	6.8	ns
^t PZL] UE	A, B, 01 C	2.4	7.2	2.4	7.1	115
^t PHZ	ŌĒ	A, B, or C	1	6.4	1	6.2	ns
t _{PLZ}	7	Λ, Β, 01 C	2	6.4	2	6	115

PARAMETER MEASUREMENT INFORMATION



NOTES: A. C_L includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics: PRR \leq 10 MHz, Z_{Q} = 50 Ω , $t_{f} \leq$ 2.5 ns, $t_{f} \leq$ 2.5 ns.
- D. The outputs are measured one at a time with one transition per measurement.

Figure 1. Load Circuit and Voltage Waveforms

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PACKAGING INFORMATION

Orderable part number	Status (1)	Material type	Package Pins	Package qty Carrier	RoHS (3)	Lead finish/ Ball material	MSL rating/ Peak reflow	Op temp (°C)	Part marking (6)
SN74ABTH32318PN	Active	Production	LQFP (PN) 80	119 JEDEC TRAY (10+1)	Yes	NIPDAU	Level-3-260C-168 HR	-40 to 85	ABTH32318
SN74ABTH32318PN.B	Active	Production	LQFP (PN) 80	119 JEDEC TRAY (10+1)	Yes	NIPDAU	Level-3-260C-168 HR	-40 to 85	ABTH32318

⁽¹⁾ Status: For more details on status, see our product life cycle.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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⁽²⁾ Material type: When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

⁽³⁾ RoHS values: Yes, No, RoHS Exempt. See the TI RoHS Statement for additional information and value definition.

⁽⁴⁾ Lead finish/Ball material: Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

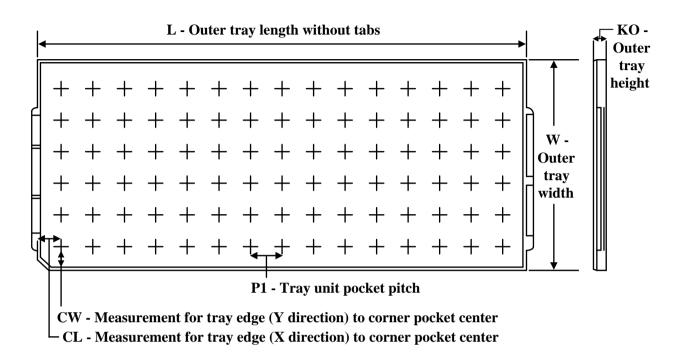
⁽⁵⁾ MSL rating/Peak reflow: The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

⁽⁶⁾ Part marking: There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.



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TRAY



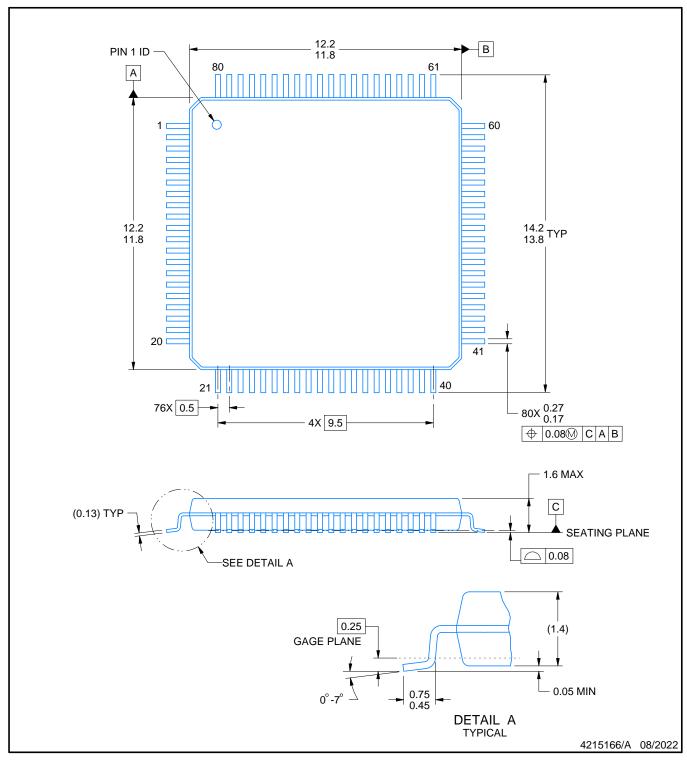
Chamfer on Tray corner indicates Pin 1 orientation of packed units.

*All dimensions are nominal

Device	Package Name	Package Type	Pins	SPQ	Unit array matrix	Max temperature (°C)	L (mm)	W (mm)	Κ0 (μm)	P1 (mm)	CL (mm)	CW (mm)
SN74ABTH32318PN	PN	LQFP	80	119	7 x 17	150	315	135.9	7620	17.9	14.3	13.95
SN74ABTH32318PN.B	PN	LQFP	80	119	7 x 17	150	315	135.9	7620	17.9	14.3	13.95



PLASTIC QUAD FLATPACK



NOTES:

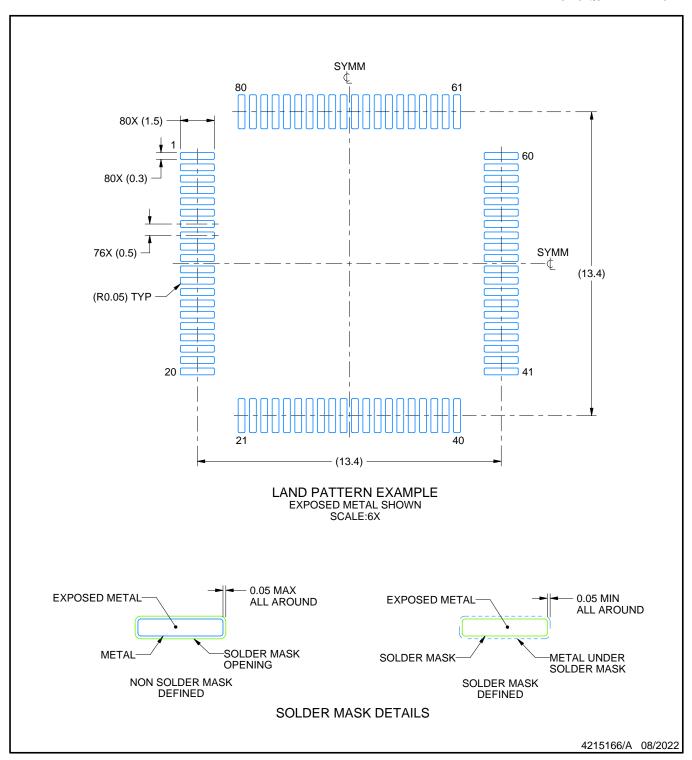
- 1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.

 2. This drawing is subject to change without notice.

 3. Reference JEDEC registration MS-026.



PLASTIC QUAD FLATPACK

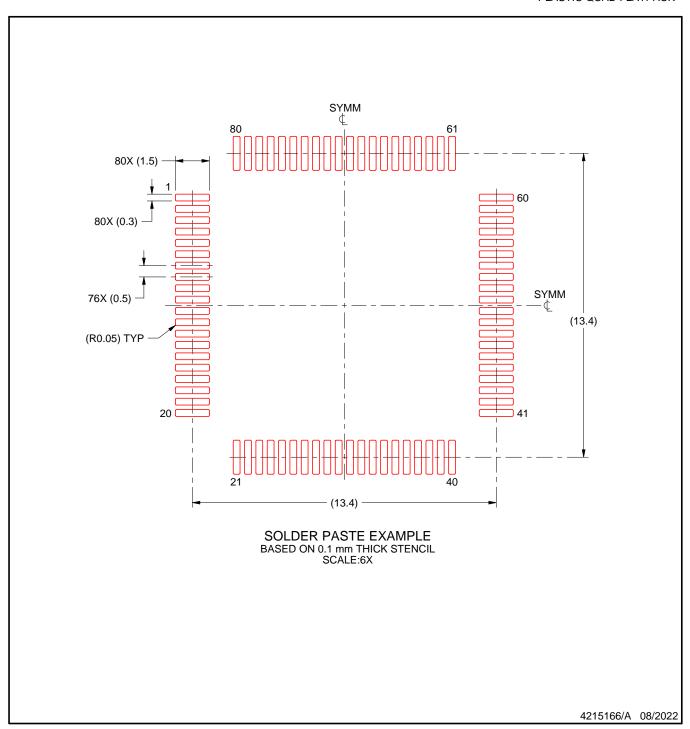


NOTES: (continued)

- 4. Publication IPC-7351 may have alternate designs.
- Solder mask tolerances between and around signal pads can vary based on board fabrication site.
 For more information, see Texas Instruments literature number SLMA004 (www.ti.com/lit/slma004).



PLASTIC QUAD FLATPACK



NOTES: (continued)



^{7.} Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.

^{8.} Board assembly site may have different recommendations for stencil design.

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